

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
TIE LI	02/10/2020
AISHENG YU	02/10/2020
WEI LI	02/10/2020
YUELIN WANG	02/10/2020
RECEIVING PARTY DATA	
Name:	SHANGHAI INSTITUTE OF MICROSYSTEM AND INFORMATION TECHNOLOGY, CHINESE ACADEMY OF SCIENCES
Street Address:	NO. 865 CHANGNING ROAD
Internal Address:	CHANG NING DISTRICT
City:	SHANGHAI
State/Country:	CHINA
Postal Code:	200050
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16638070
CORRESPONDENCE DATA	
Fax Number:	(414)225-9753
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	414-225-9755
Email:	docketing@boylefred.com
Correspondent Name:	BOYLE FREDRICKSON S.C.
Address Line 1:	840 NORTH PLANKINTON AVENUE
Address Line 4:	MILWAUKEE, WISCONSIN 53203
ATTORNEY DOCKET NUMBER:	3330.004
NAME OF SUBMITTER:	BRAD L. MEYER
SIGNATURE:	/Brad L. Meyer/
DATE SIGNED:	02/19/2020
Total Attachments: 7	
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ASSIGNMENT

ASSIGNMENT made by **TIE LI**, of No. 865, Changning Road, Chang Ning District, Shanghai 200050 CN, **AISHENG YU** of No. 865, Changning Road, Chang Ning District, Shanghai 200050 CN, **WEI LI** of No. 865, Changning Road, Chang Ning District, Shanghai 200050 CN and **YUELIN WANG** of No. 865, Changning Road, Chang Ning District, Shanghai 200050 CN to **SHANGHAI INSTITUTE OF MICROSYSTEM AND INFORMATION TECHNOLOGY, CHINESE ACADEMY OF SCIENCES**, a corporation organized under the laws of China, and located and doing business at No. 865, Changning Road, Chang Ning District, Shanghai 200050 CN.

IN CONSIDERATION of One Dollar (\$1.00) and other good and valuable considerations, the receipt of which is hereby acknowledged, said **TIE LIE**, **AISHENG YU**, **WEI LI** and **YUELIN WANG**, hereby sell, assign and transfer to said **SHANGHAI INSTITUTE OF MICROSYSTEM AND INFORMATION TECHNOLOGY, CHINESE ACADEMY OF SCIENCES**, its successors and assigns, the entire right, title and interest in:

ELECTROMAGNETIC ABSORPTION METAMATERIAL

and the invention therein as set forth in their application for United States Letters Patent therefor, Serial No. 16/638,070 filed February 10, 2020, and in and to said application and any divisions, continuations, or continuations-in-part thereof, and any Letters Patent obtained for the said invention in the United States and foreign countries, or issuing out of said application or any such division or continuation thereof, and any reissues or extensions of any such Letters Patent.

The Commissioner of Patents is hereby authorized and requested to issue Letters Patent for said invention to said **SHANGHAI INSTITUTE OF MICROSYSTEM AND**

INFORMATION TECHNOLOGY, CHINESE ACADEMY OF SCIENCES, as assignee of the entire right, title and interest therein.

And, said **TIE LIE, AISHENG YU, WEI LI and YUELIN WANG**, hereby covenant that they have full right to convey the entire right, title and interest in said invention, and that they have not executed and will not execute any agreement in conflict herewith.

And, they further covenant that they will, at any time, upon request, execute and deliver any and all papers that may be necessary or desirable to perfect the title in said **SHANGHAI INSTITUTE OF MICROSYSTEM AND INFORMATION TECHNOLOGY, CHINESE ACADEMY OF SCIENCES**, to said invention or any Letters Patent that may be granted therefor, and that if said **SHANGHAI INSTITUTE OF MICROSYSTEM AND INFORMATION TECHNOLOGY, CHINESE ACADEMY OF SCIENCES**, or its assignee, desires to make a substitute, divisional or continuation application for said invention, or to secure a reissue or extension of said Letters Patent, to file a disclaimer relating thereto, or an application for a corresponding patent in any foreign country, that they will, upon request, sign all papers, make all rightful oaths, and do all lawful acts requisite for the said purpose, but at the expense of said **SHANGHAI INSTITUTE OF MICROSYSTEM AND INFORMATION TECHNOLOGY, CHINESE ACADEMY OF SCIENCES**.

And, they further covenant and acknowledge that the entire beneficial interest in the invention to which the above application relates is irrevocably vested in the assignee including the right to make applications for protection in all countries abroad and to claim priority under the International Convention for such applications and hereby assent to the making of any such applications, with or without priority claim, and of any divisional applications resulting therefrom.

And, they further covenant that they will at all times, communicate to the said **SHANGHAI INSTITUTE OF MICROSYSTEM AND INFORMATION TECHNOLOGY, CHINESE ACADEMY OF SCIENCES**, its successors, assigns, or legal representatives, all facts relating to said invention and Letters Patent, or the history thereof, known to them, and testify as to the same in interferences or other litigation when requested so to do.

They also hereby authorize the law firm of Boyle Fredrickson S.C., and all attorneys associated with Customer Account No. 23598 the power to insert in this instrument any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent Office for recordation of this document.

Executed and delivered this _____ day of _____, 20____.

TIE LI

Witness Signature: _____

Witness Name: _____

Date: _____

SHANGHAI INSTITUTE OF MICROSYSTEM AND INFORMATION

TECHNOLOGY, CHINESE ACADEMY OF SCIENCES, its successors, assigns, or legal representatives, all facts relating to said invention and Letters Patent, or the history thereof, known to them, and testify as to the same in interferences or other litigation when requested so to do.

They also hereby authorize the law firm of Boyle Fredrickson S.C., and all attorneys associated with Customer Account No. 23598 the power to insert in this instrument any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent Office for recordation of this document.

Executed and delivered this 10 day of February, 2020.



TIE LI

Witness Signature: _____

Witness Name: _____

Date: _____

Executed and delivered this 10 day of February, 2020

余爱生
AISHENG YU


Witness Signature: _____

Witness Name: _____

Date: _____

Attorney Docket No. 3330.004

Executed and delivered this 10 day of February, 2020.



WEI LI

Witness Signature: _____

Witness Name: _____

Date: _____

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Attorney Docket No. 3330.004

Executed and delivered this 10 day of February, 2020.



YUELIN WANG

Witness Signature: _____

Witness Name: _____

Date: _____

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